

SK 150 MHK 055 T



SEMITOP® 3

Mosfet Module

SK 150 MHK 055 T

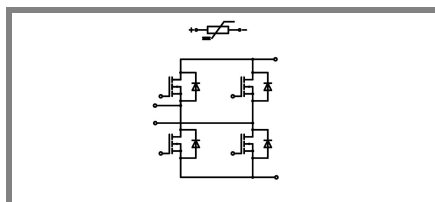
Target Data

Features

- Compact design
- One screw mounting
- Heat transfer and isolation through direct copper bonded aluminium oxide ceramic (DCB)
- Trench technology
- Short internal connections and low inductance case
- Integrated PTC temperature sensor

Typical Applications*

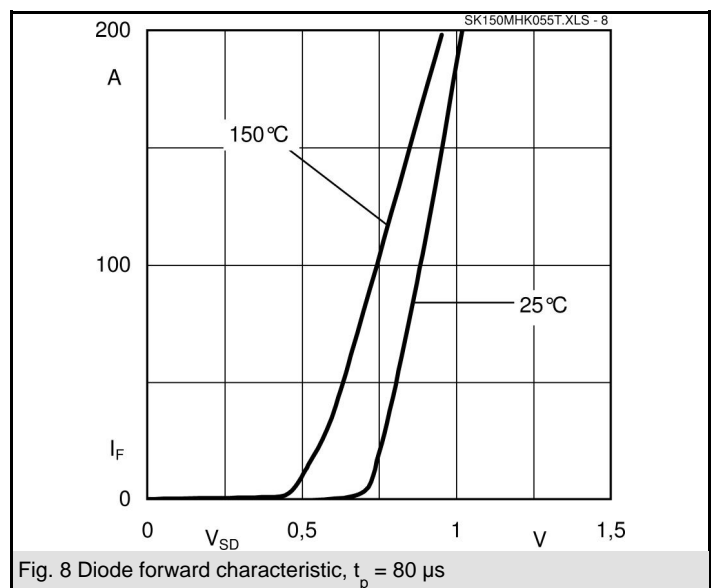
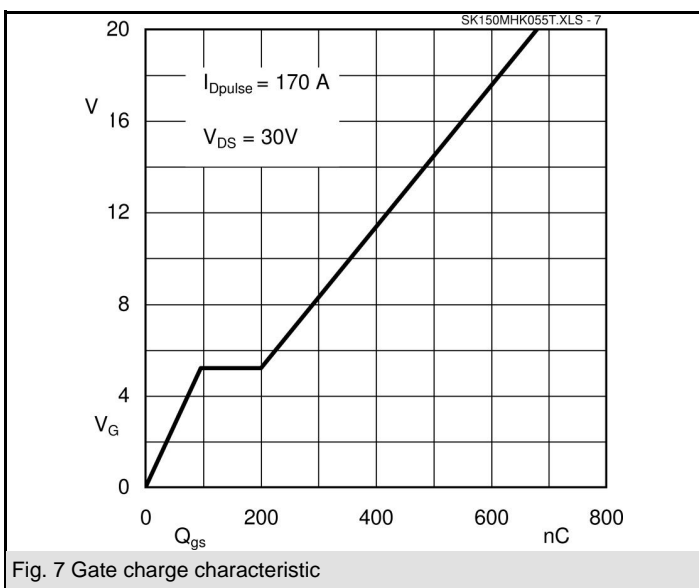
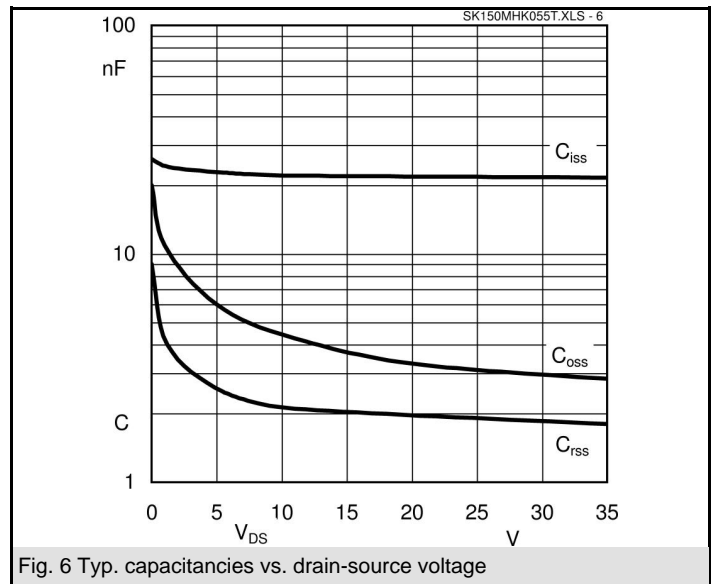
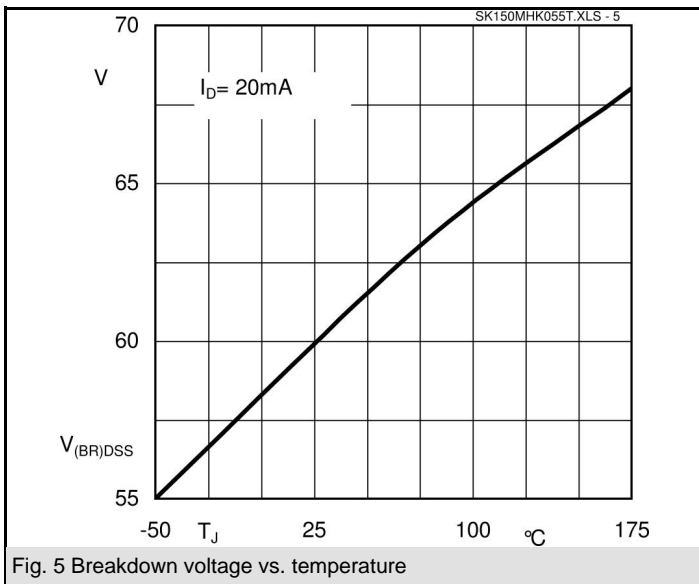
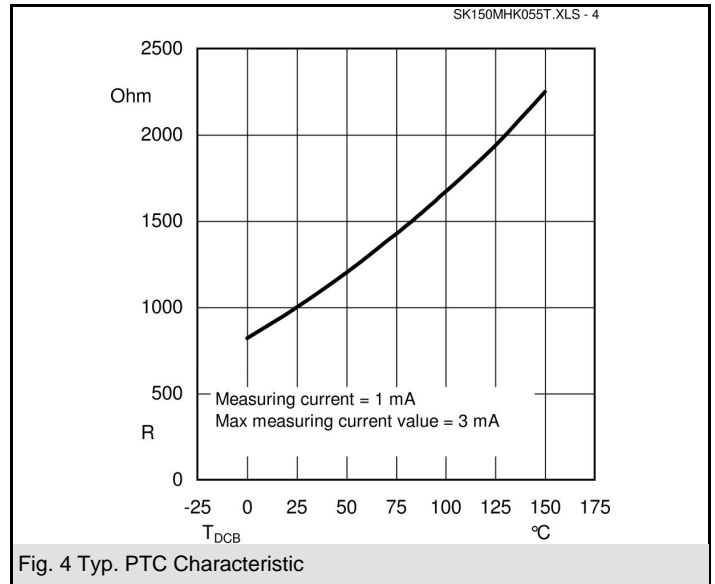
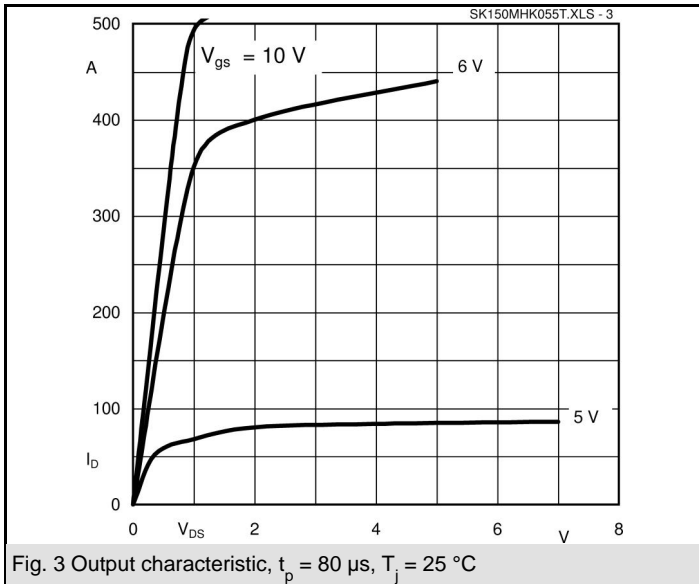
- Low switched mode power supplies
- DC servo drives
- UPS



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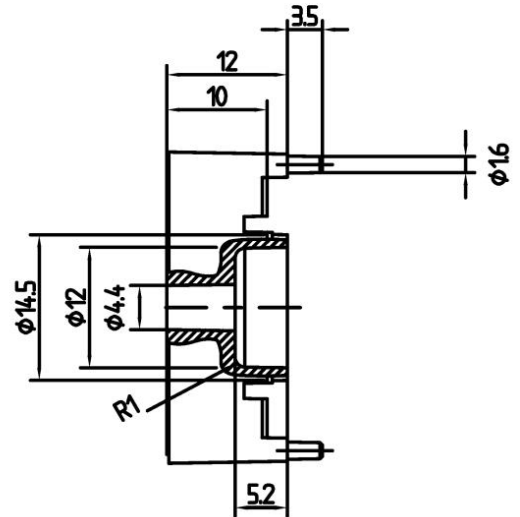
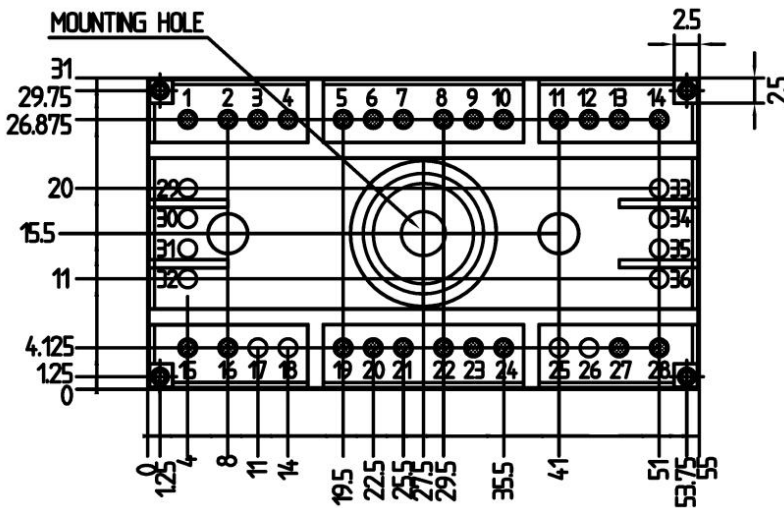
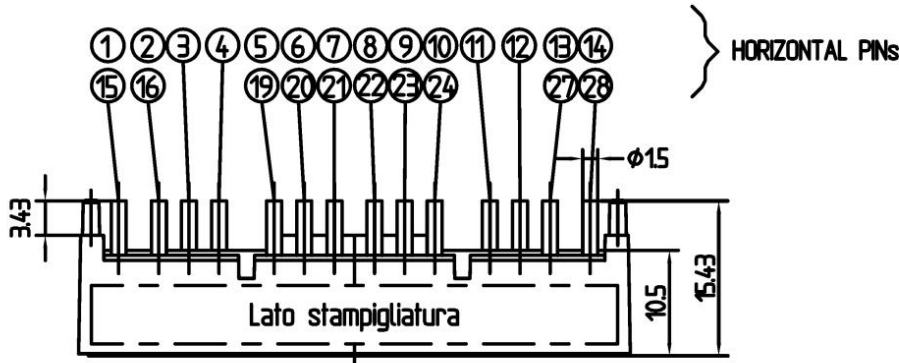
Absolute Maximum Ratings		$T_s = 25\text{ °C}$, unless otherwise specified	
Symbol	Conditions	Values	Units
MOSFET			
V_{DSS}		55	V
V_{GSS}		± 20	V
I_D	$T_s = 25\text{ (80) °C}$;	240 (150)	A
I_{DM}	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	340 (250)	A
T_j		-40...+150	°C
Inverse diode			
$I_F = -I_D$	$T_s = 25\text{ (80) °C}$;	240 (150)	A
$I_{FM} = -I_{DM}$	$t_p < 1\text{ ms}$; $T_s = 25\text{ (80) °C}$;	340 (250)	A
T_j		-40...+150	°C
Freewheeling CAL diode			
$I_F = -I_D$	$T_s = \text{°C}$		A
T_j			°C
T_{stg}		- 40 ... + 125	°C
T_{sol}	Terminals, 10 s	260	°C
V_{isol}	AC, 1 min (1s)	2500 / 3000	V

Characteristics		$T_s = 25\text{ °C}$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
MOSFET					
$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}$, $I_D = 0,25\text{ mA}$	55			V
$V_{GS(th)}$	$V_{GS} = V_{DS}$; $I_D = 0,25\text{ mA}$	2,5	3,2	4,5	V
I_{DSS}	$V_{GS} = 0\text{ V}$; $V_{DS} = V_{DSS}$; $T_j = 25\text{ (125) °C}$			1	μA
I_{GSS}	$V_{GS} = \pm 20\text{ V}$; $V_{DS} = 0\text{ V}$			100	nA
$R_{DS(on)}$	$I_D = 5\text{ A}$; $V_{GS} = 10\text{ V}$; $T_j = 25\text{ °C}$		1,1	1,5	m Ω
$R_{DS(on)}$	$I_D = 5\text{ A}$; $V_{GS} = 10\text{ V}$; $T_j = 125\text{ °C}$		1,9	2,6	m Ω
C_{CHC}	per MOSFET				pF
C_{iss}	under following conditions:		21,2		nF
C_{oss}	$V_{GS} = 0\text{ V}$; $V_{DS} = 25\text{ V}$; $f = 1\text{ MHz}$		3,3		nF
C_{riss}			1,6		nF
L_{DS}					nH
$t_{d(on)}$	under following conditions:		40		ns
t_r	$V_{DD} = 30\text{ V}$; $V_{GS} = 10\text{ V}$; $I_D = 70\text{ A}$		180		ns
$t_{d(off)}$	$R_G = 2,5\ \Omega$		70		ns
t_f			110		ns
$R_{th(j-s)}$	per MOSFET (per module)			0,8	K/W
Inverse diode					
V_{SD}	$I_F = 5\text{ A}$; $V_{GS} = 0\text{ V}$; $T_j = 25\text{ °C}$		0,7	1,5	V
I_{RRM}	under following conditions:		8		A
Q_{rr}	$I_F = 150\text{ A}$; $T_{vj} = 25\text{ °C}$; $R_G = 2,5\ \Omega$		0,35		μC
t_{rr}	$V_R = 30\text{ A}$; $di/dt = 100\text{ A}/\mu\text{s}$		80		ns
Free-wheeling diode					
V_F	$I_F = \text{A}$; $V_{GS} = \text{V}$				V
I_{RRM}	under following conditions:				A
Q_{rr}	$I_F = \text{A}$; $T_{vj} = \text{°C}$				μC
t_{rr}	$V_r = \text{A}$; $di/dt = \text{A}/\mu\text{s}$				ns
Mechanical data					
M1	mounting torque			2,5	Nm
w			30		g
Case	SEMITOP® 3		T 64		



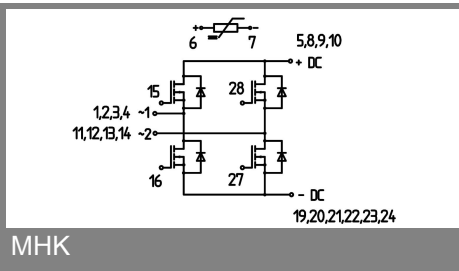
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Dimensions in mm



SUGGESTED HOLEDIAMETER FOR THE SOLDER PINS AND THE MOUNTING PINS IN THE PCB: 2 mm

Case T64



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This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.